

6558107

31
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class 144.5
part

FIG. 1

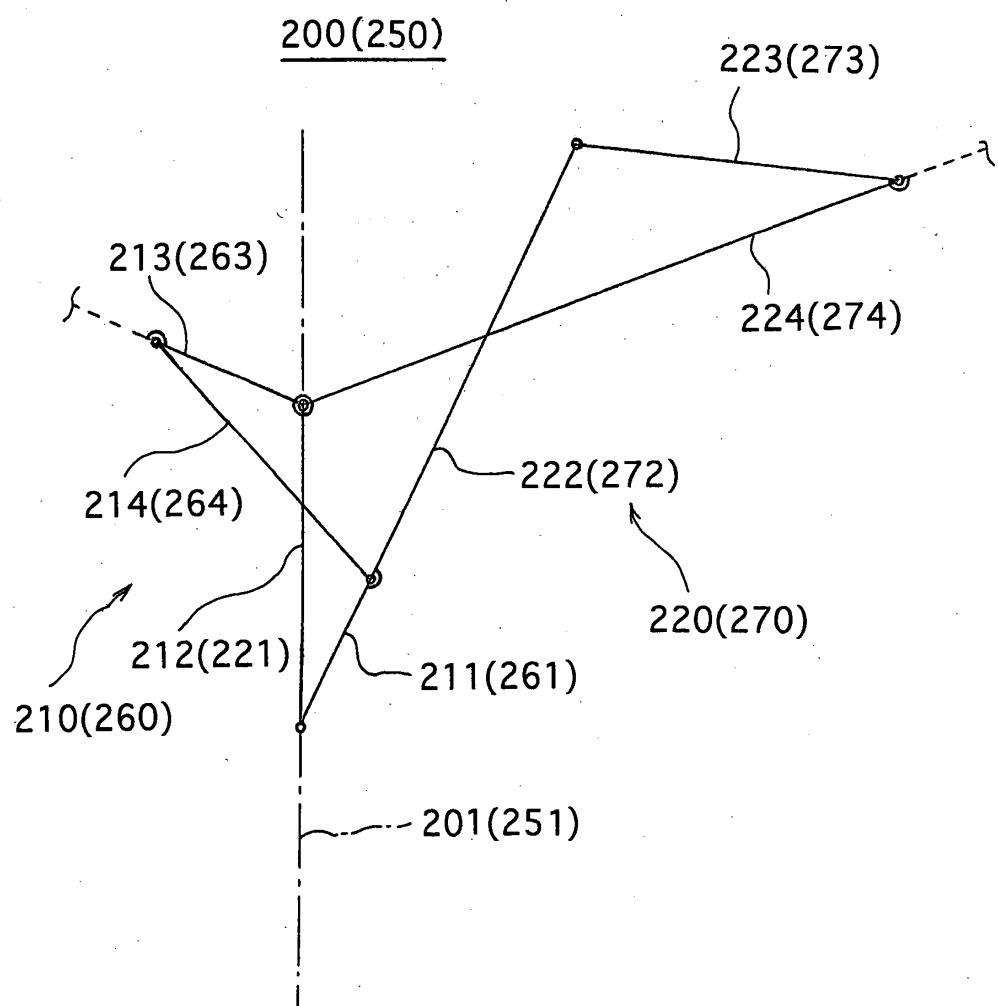


FIG. 2

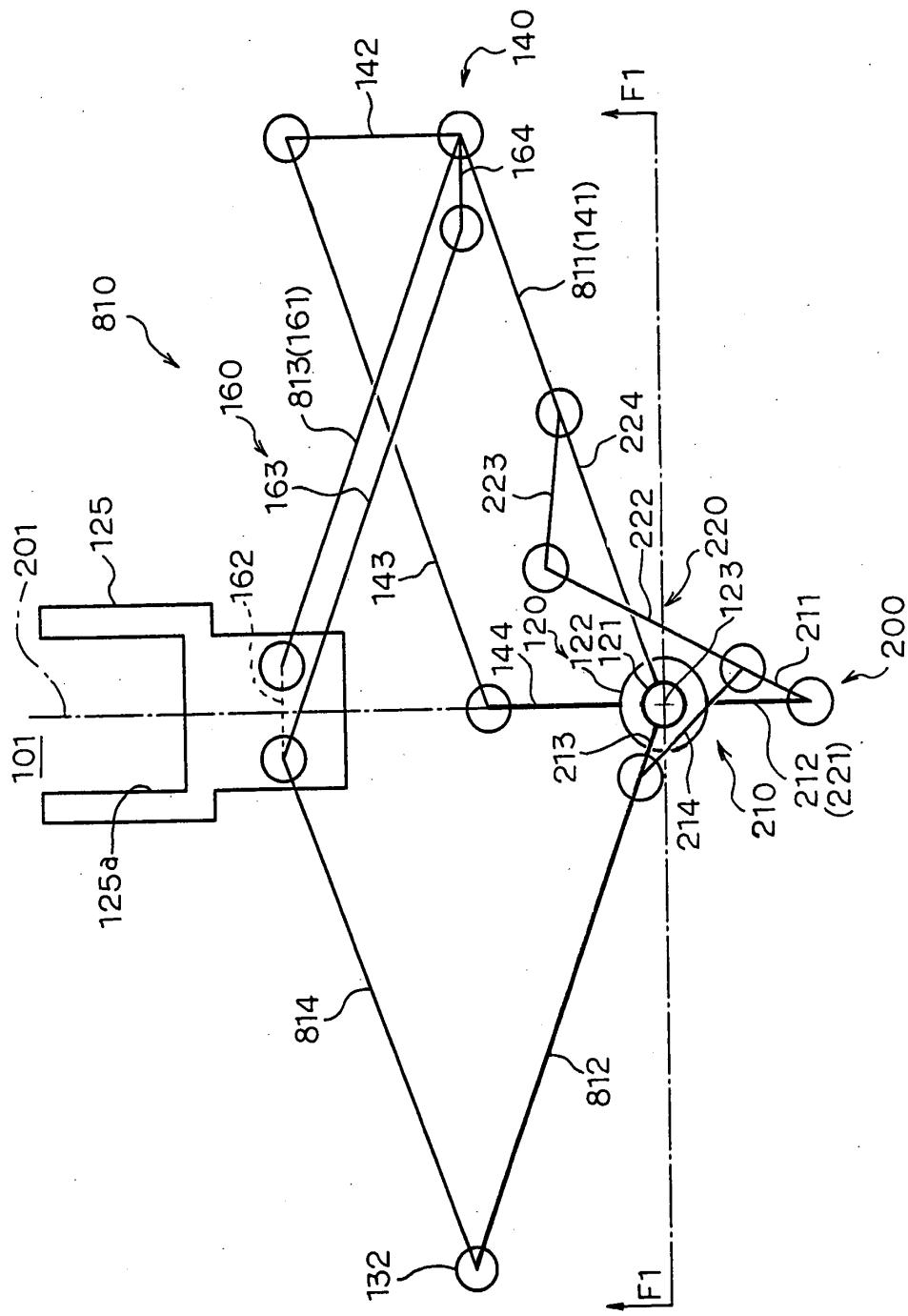


FIG. 3

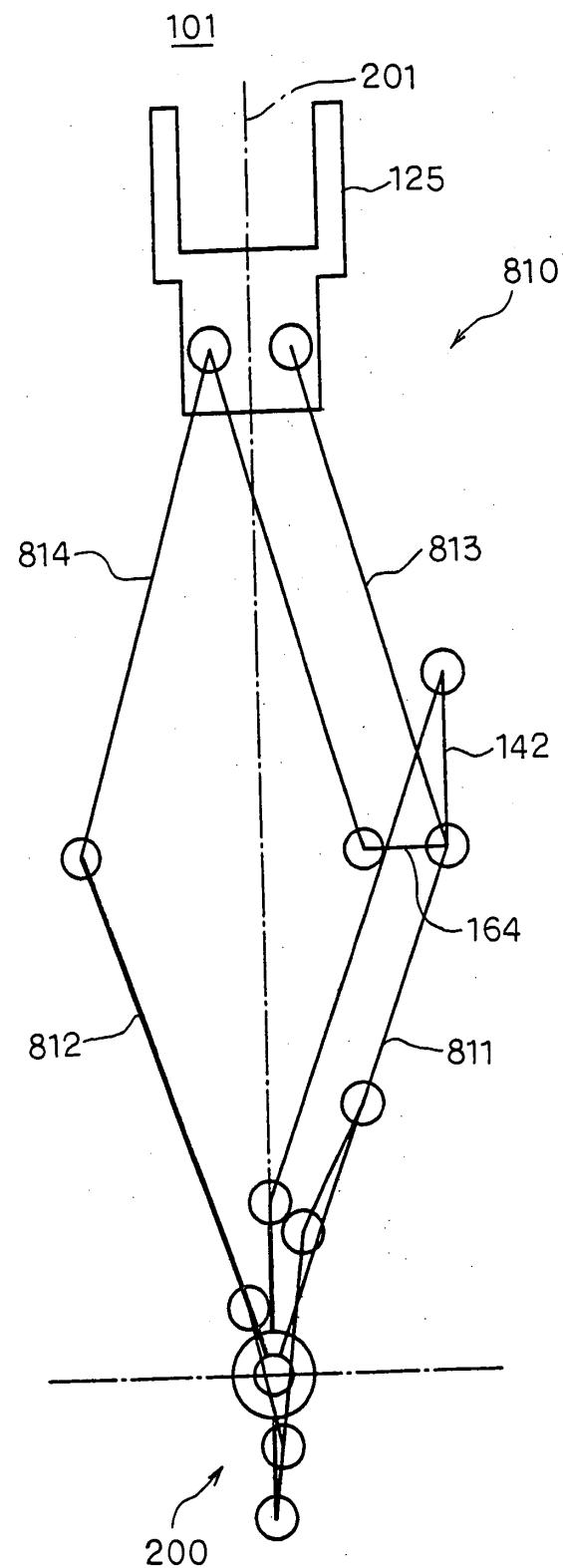


FIG. 4

FIG. 4: A cross-sectional diagram of a layered structure, likely a semiconductor device, showing various layers and contacts. The diagram is labeled with component numbers:

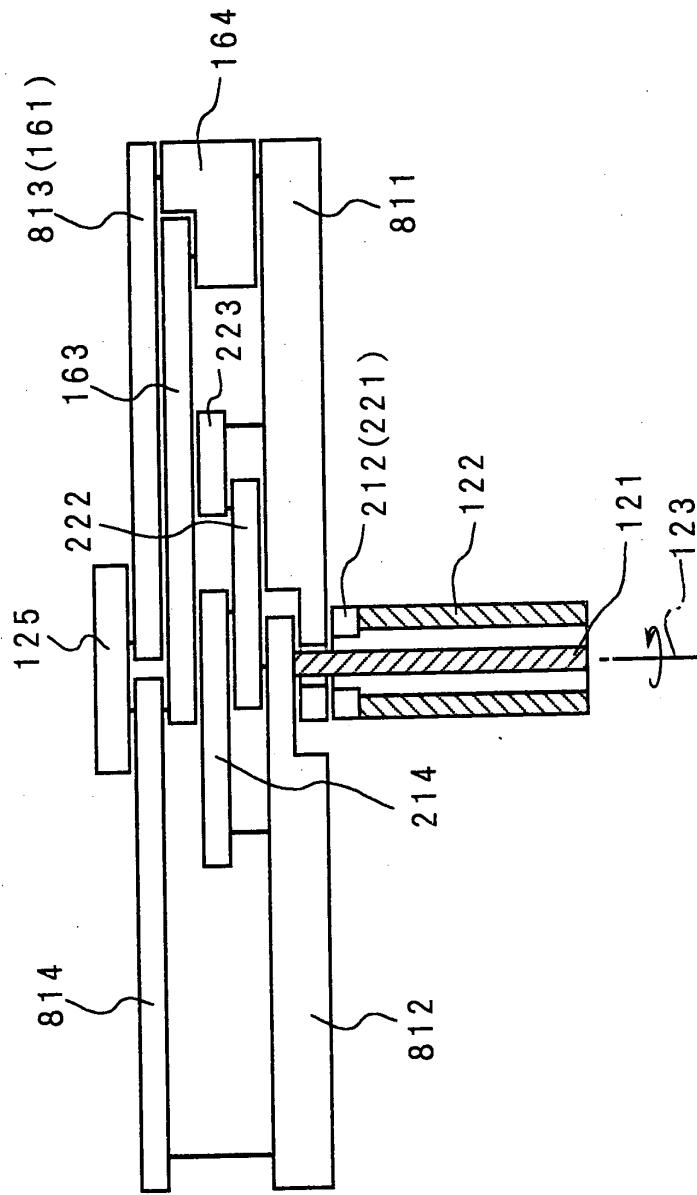


FIG. 5

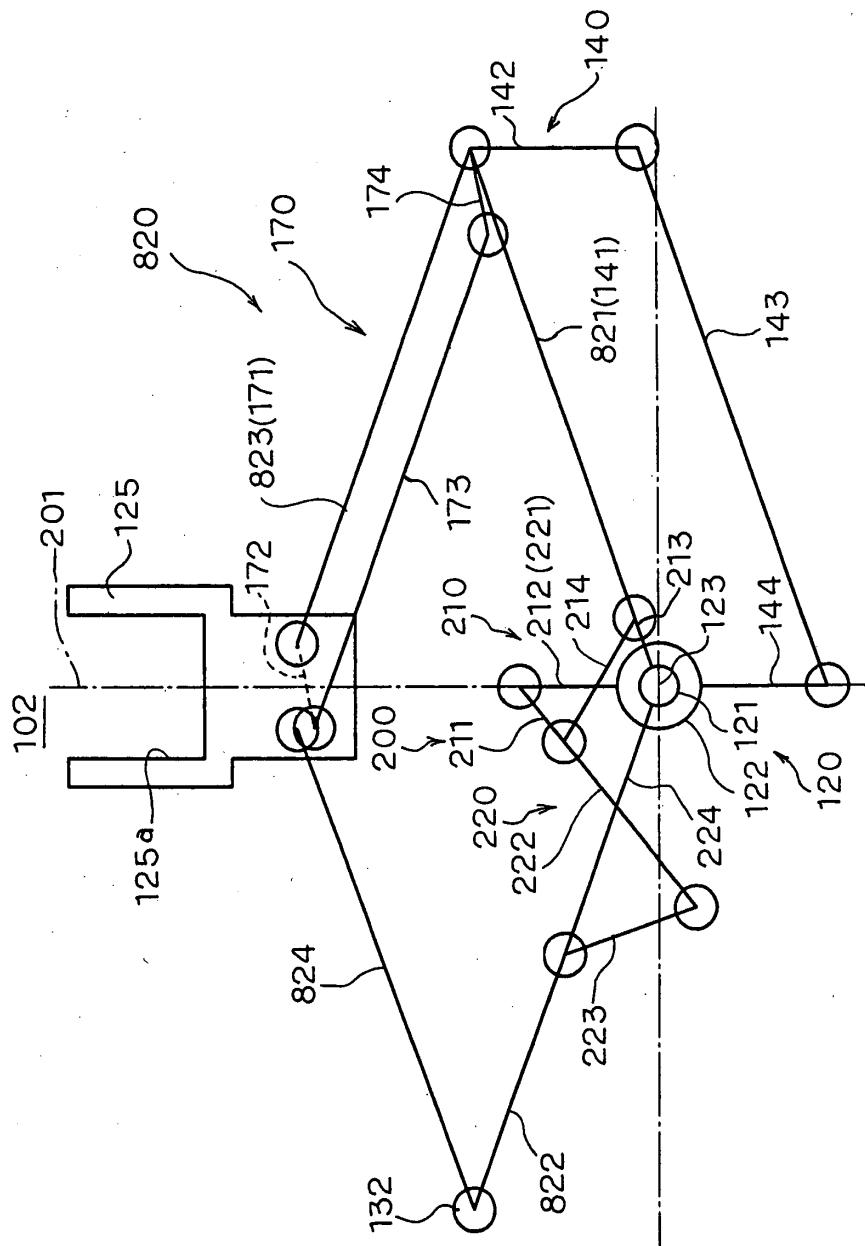


FIG. 6

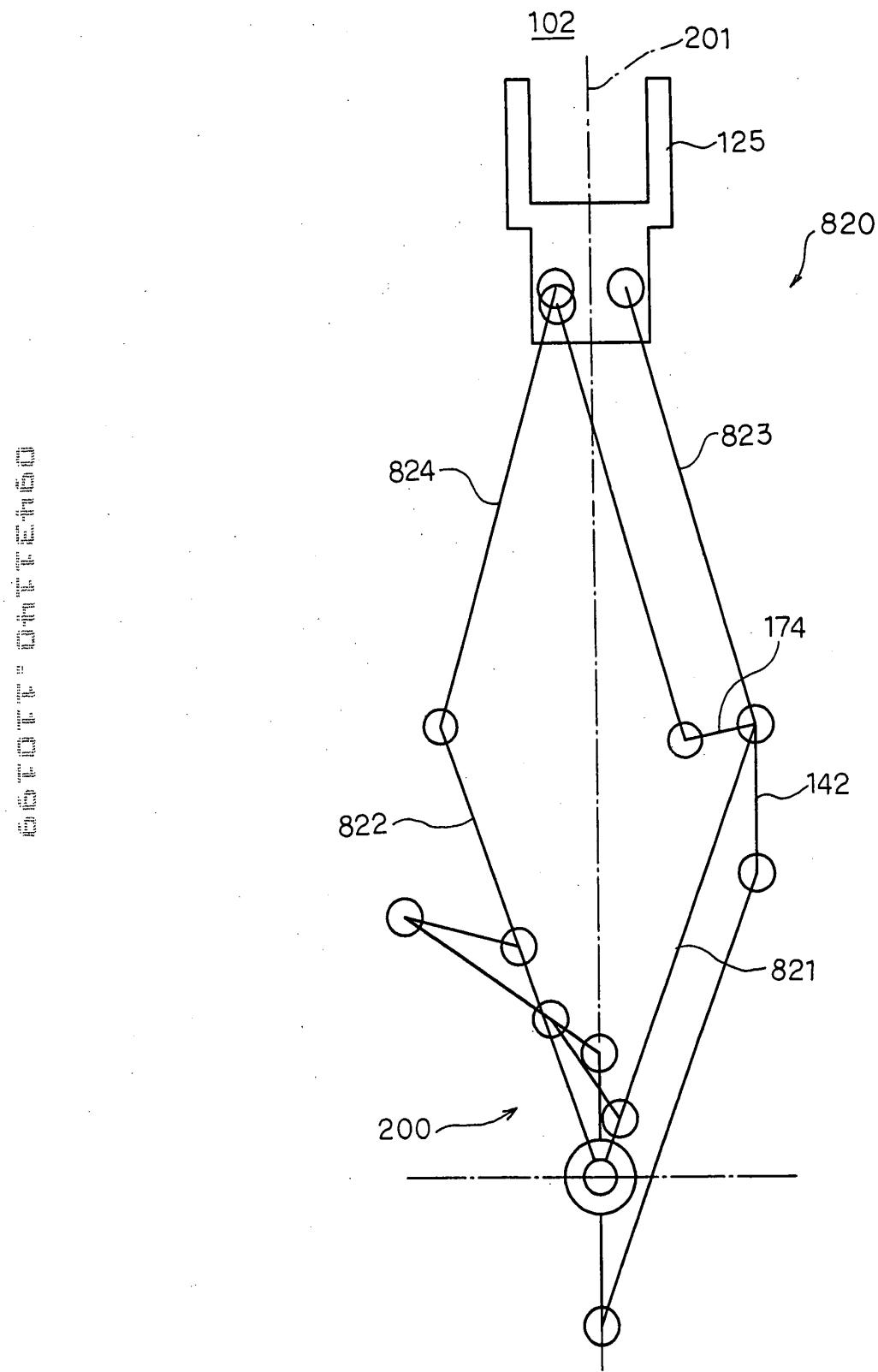


FIG. 7

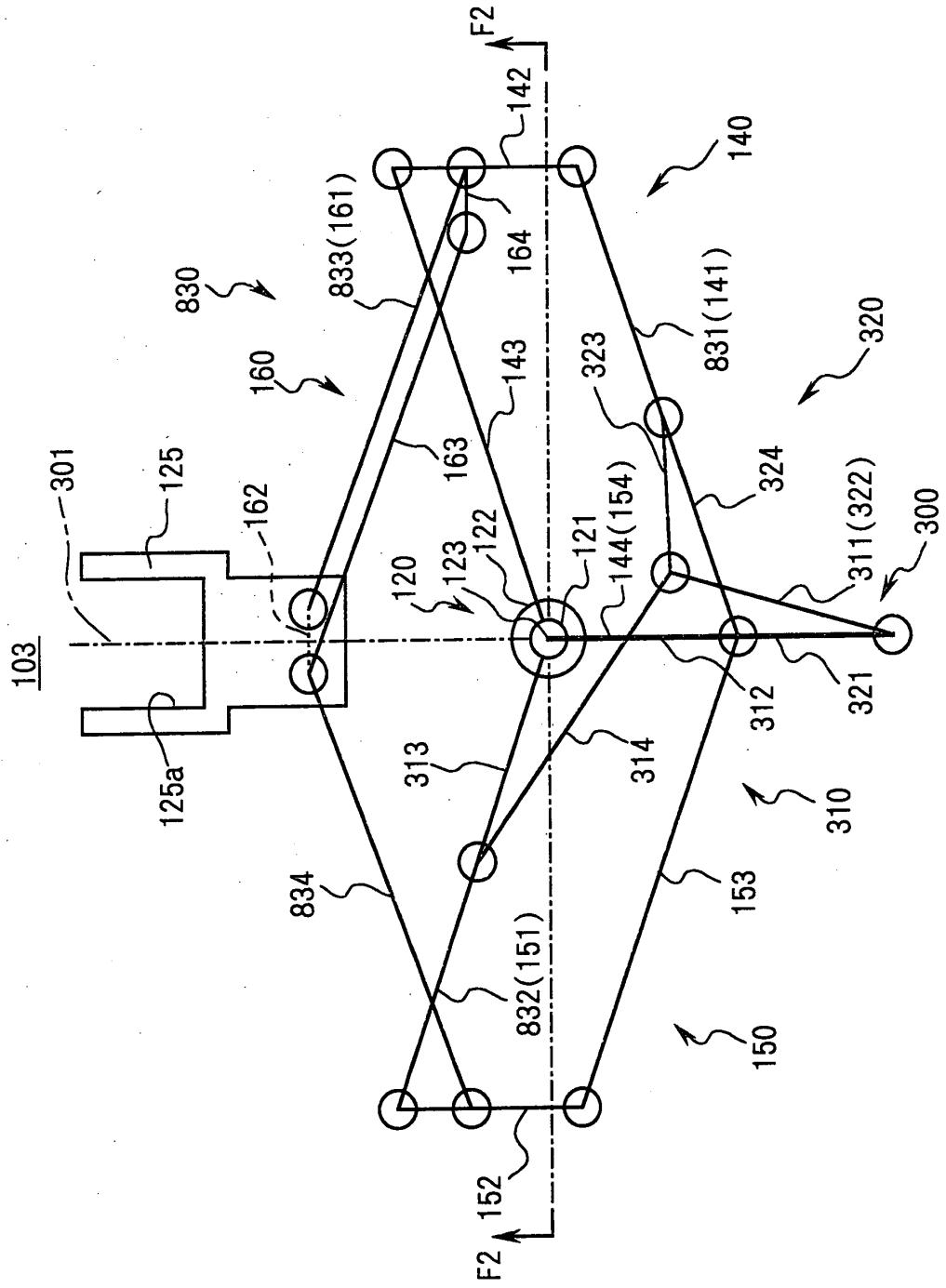


FIG. 8

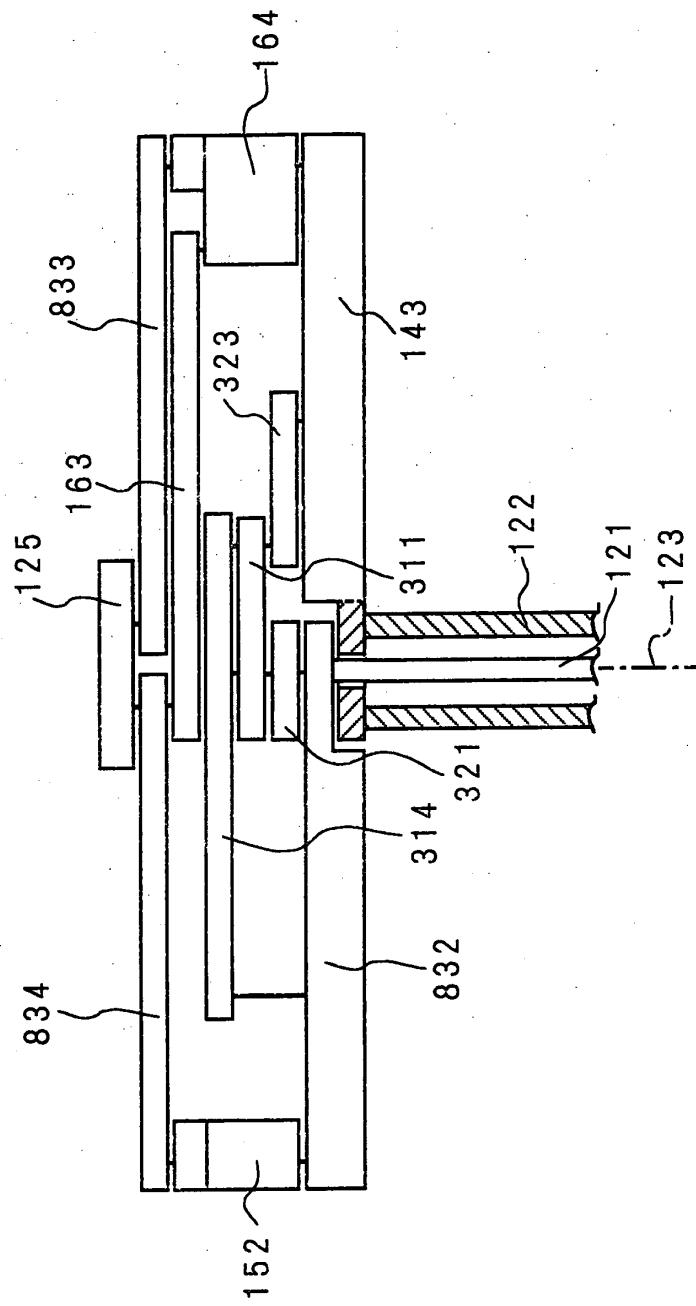


FIG. 9

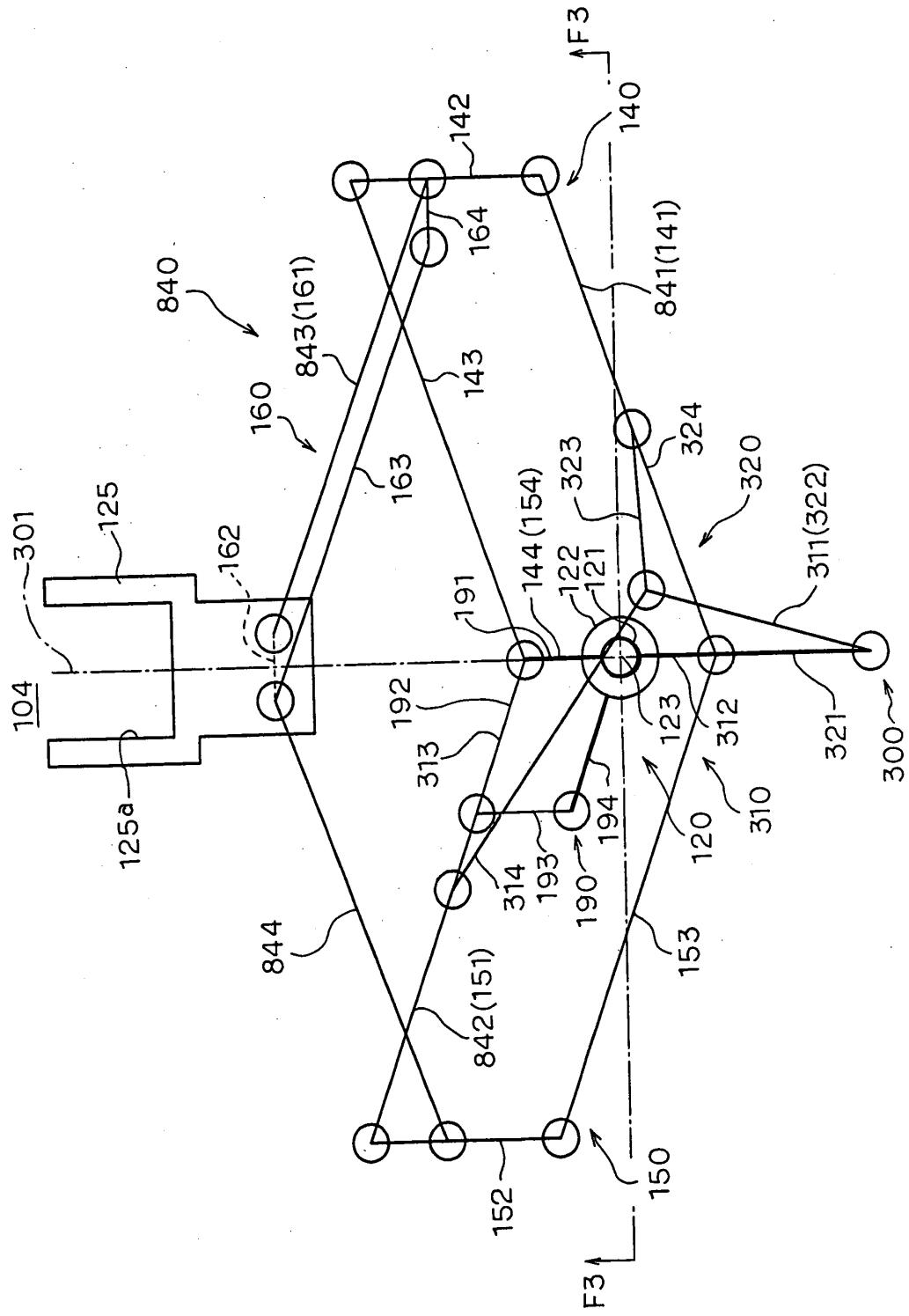


FIG. 10

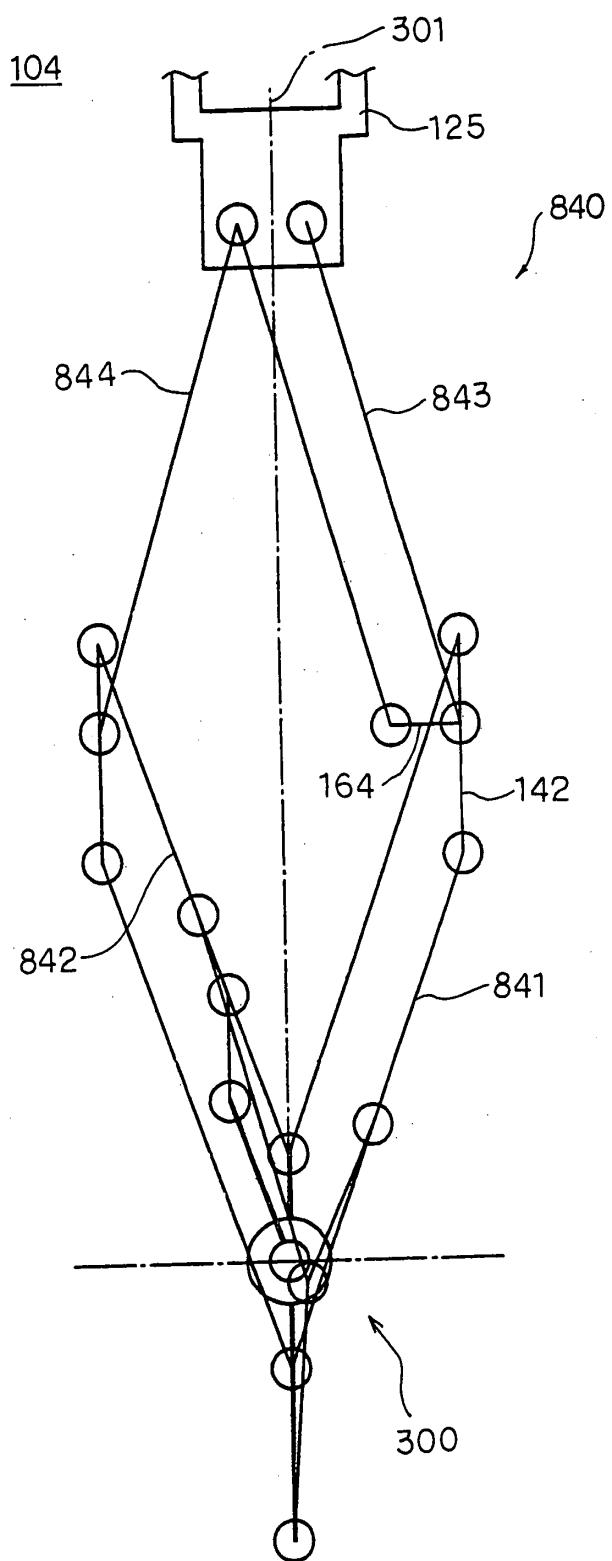


FIG. 11

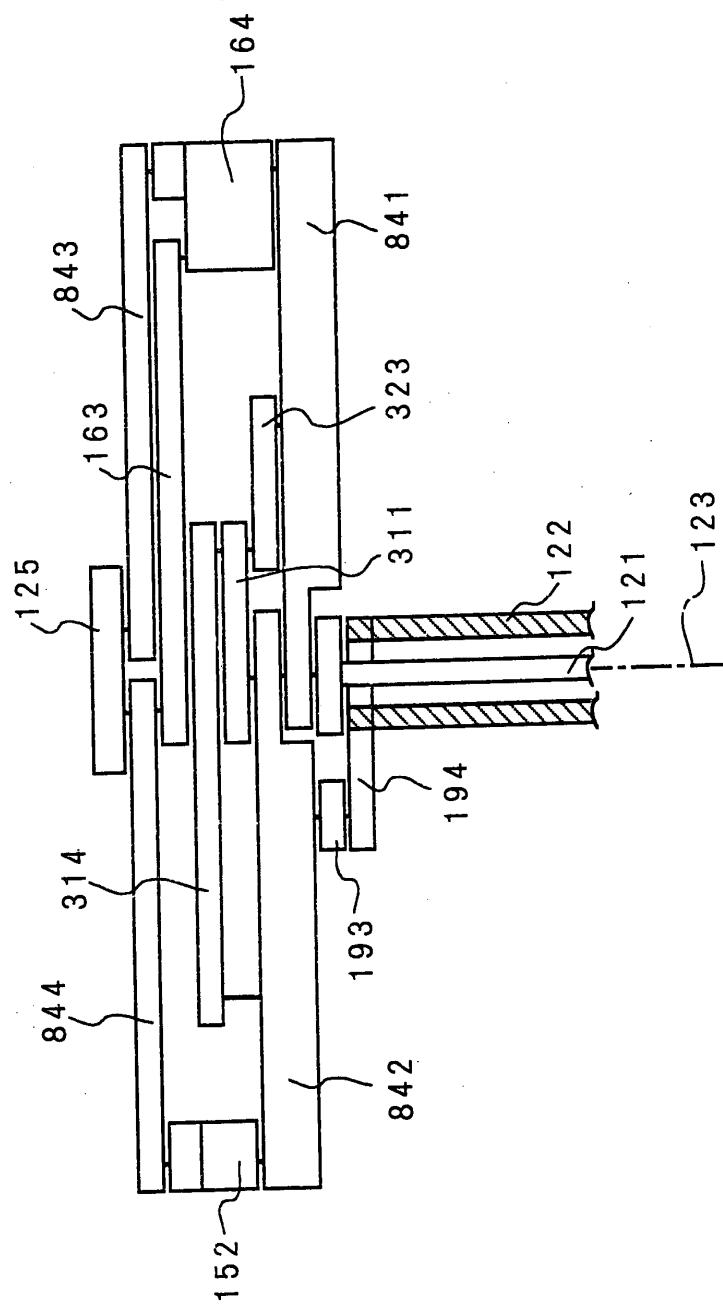


FIG. 1 2

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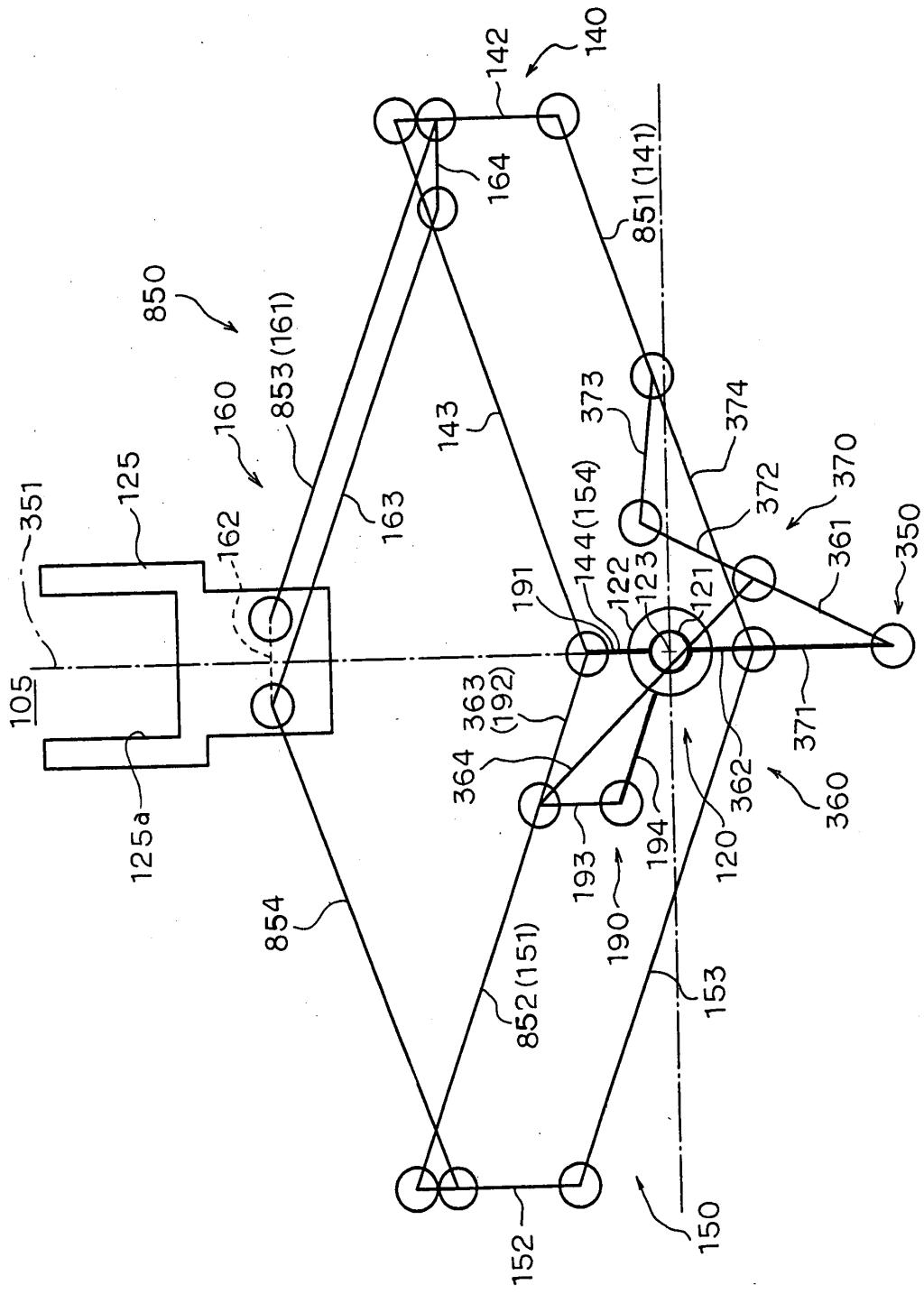


FIG. 13

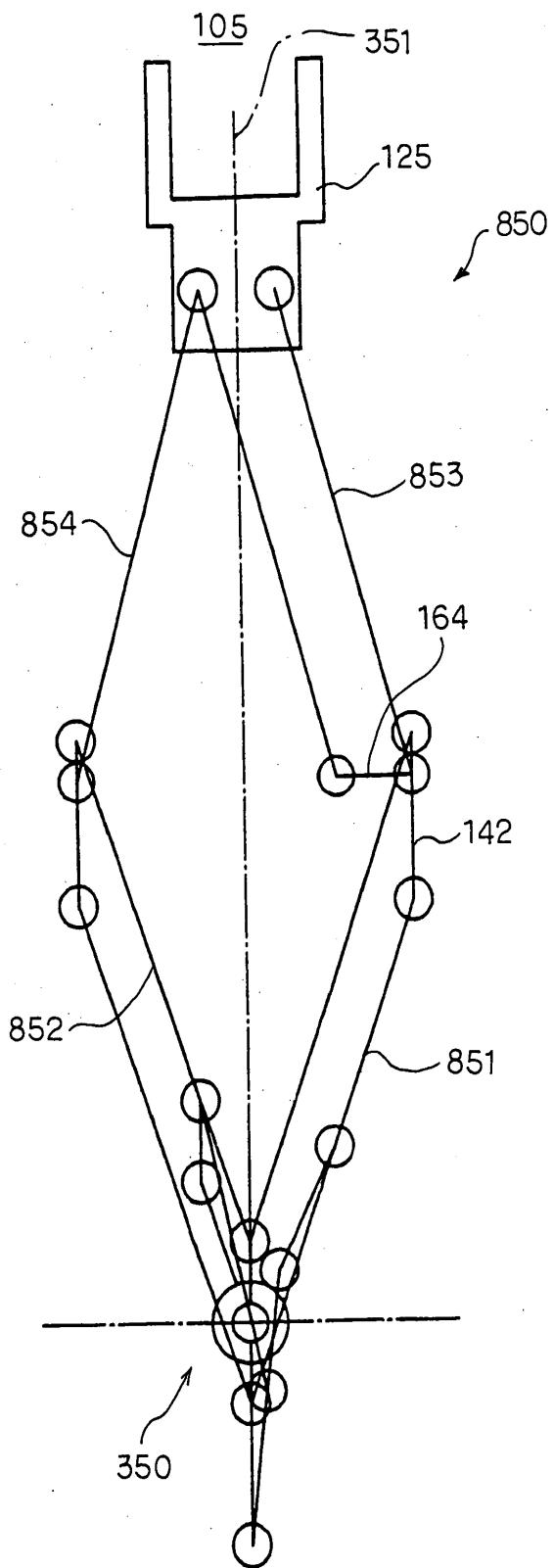


FIG. 14

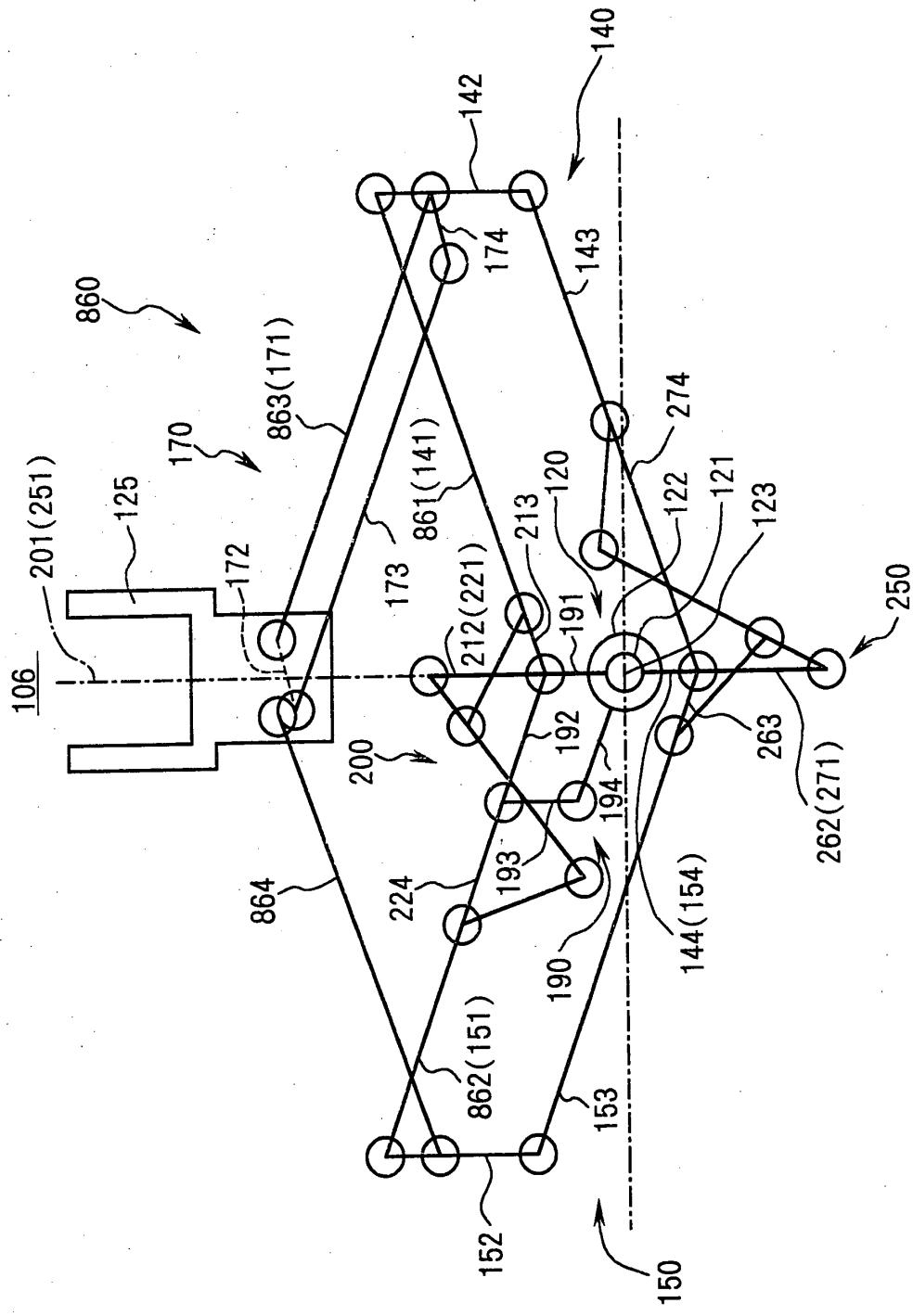


FIG. 15

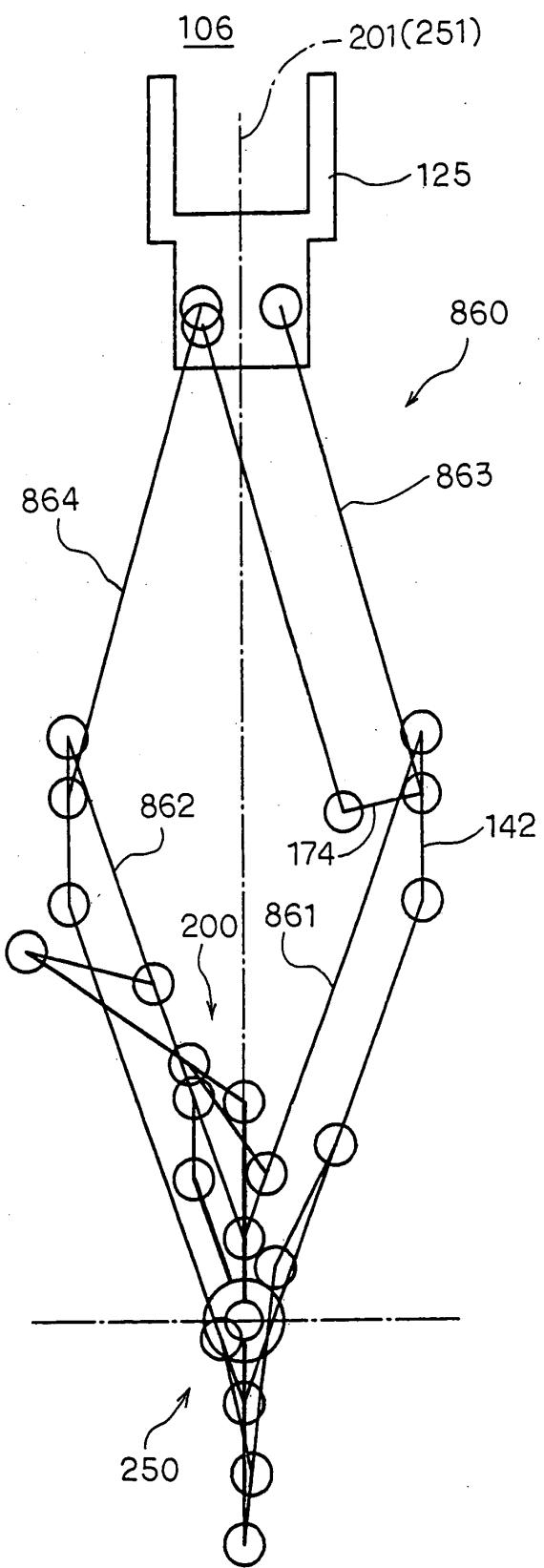
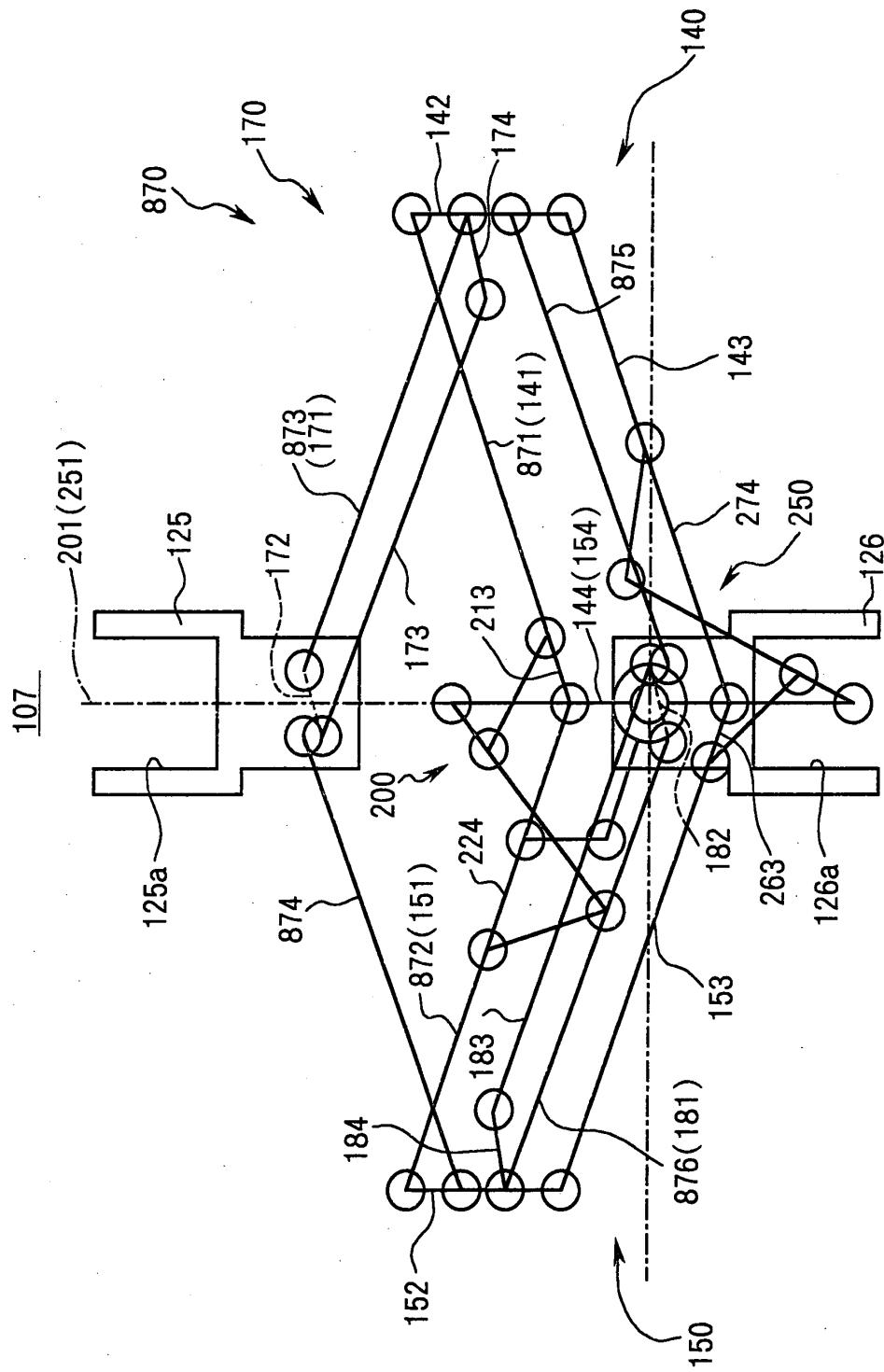
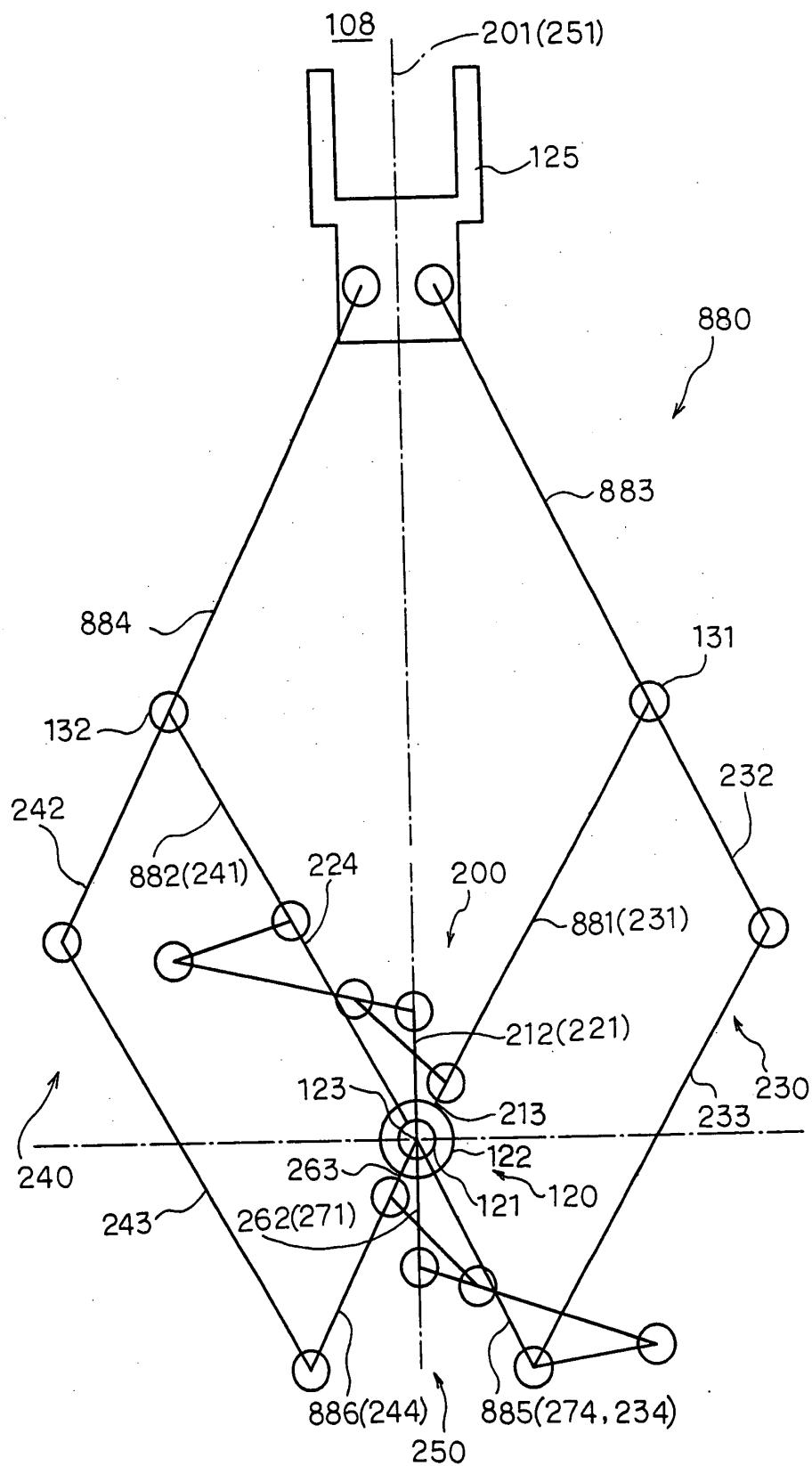


FIG. 16



F I G. 17



F I G. 18

400(450)

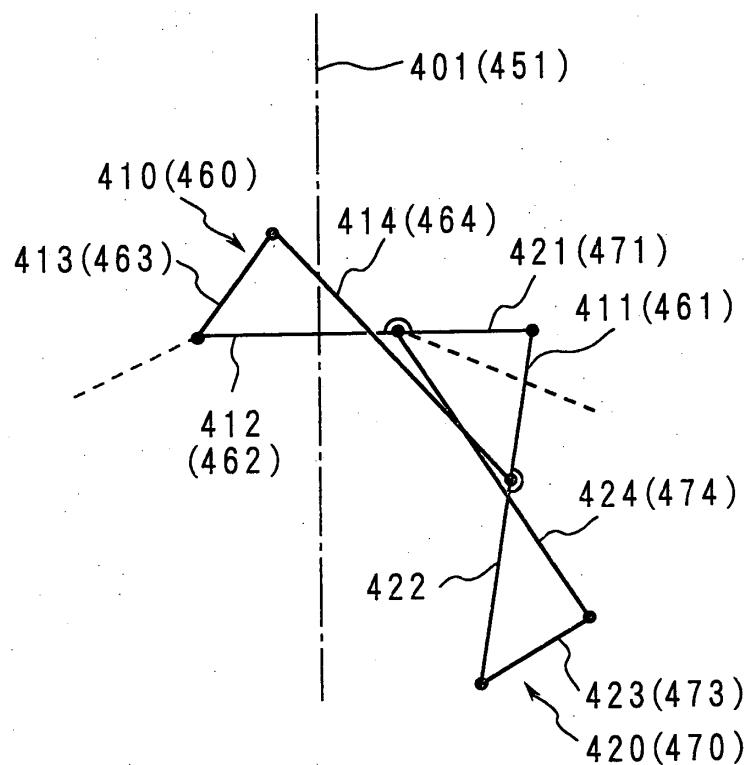


FIG. 19

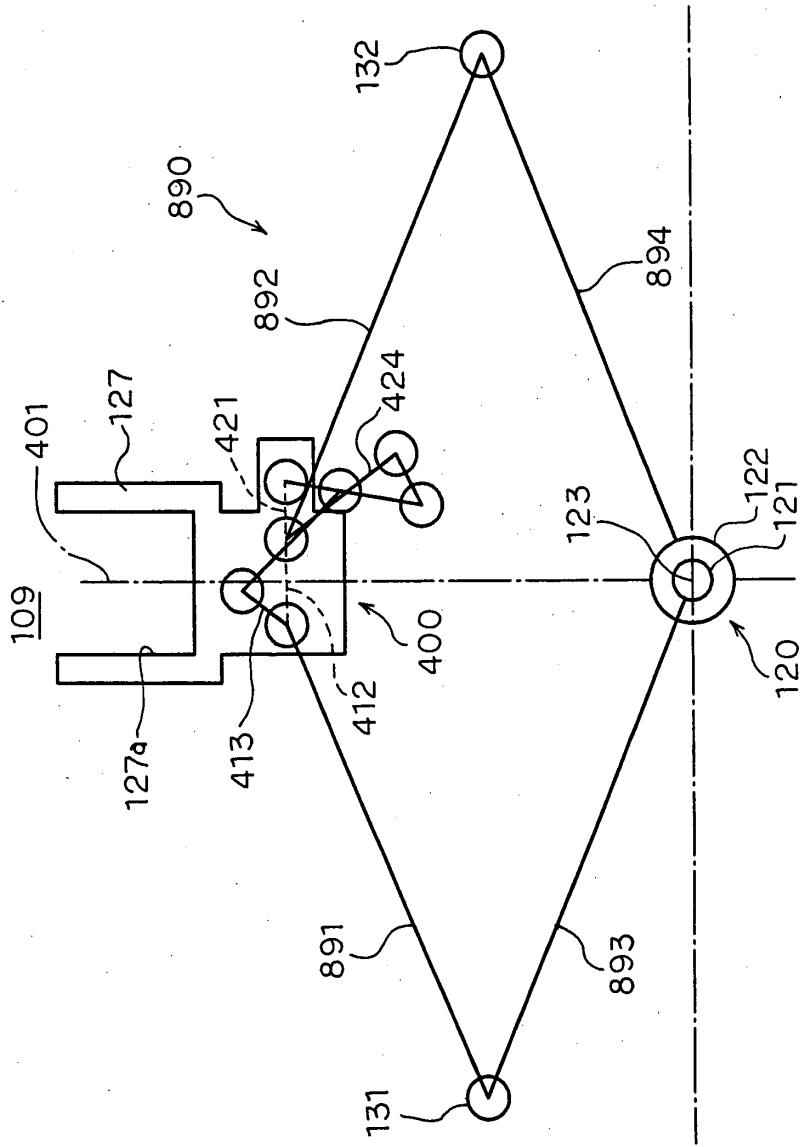


FIG. 20

500(550)

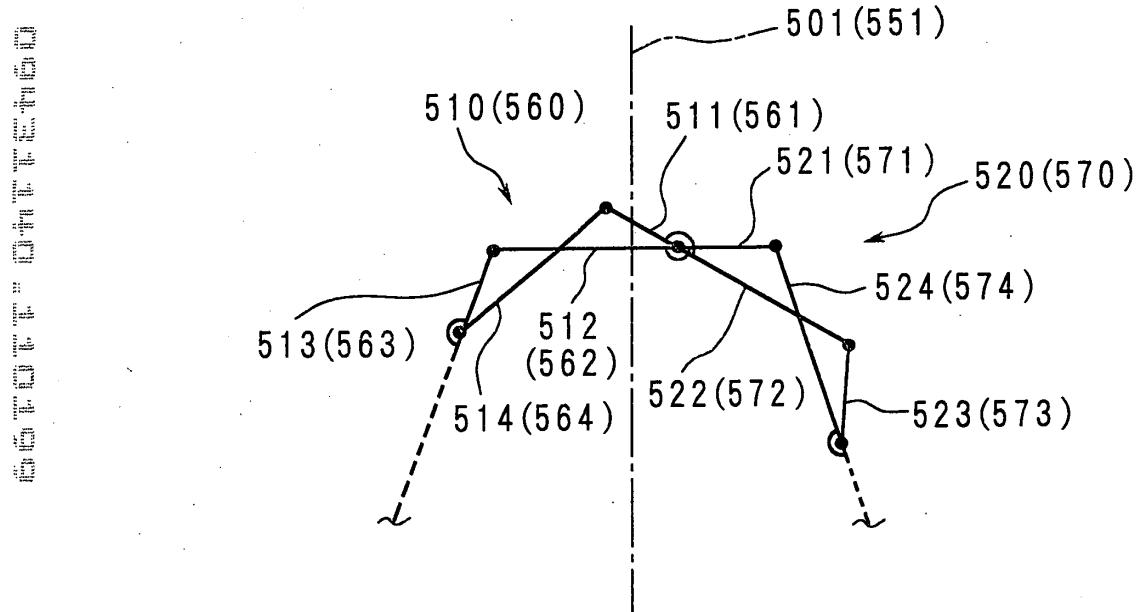


FIG. 21

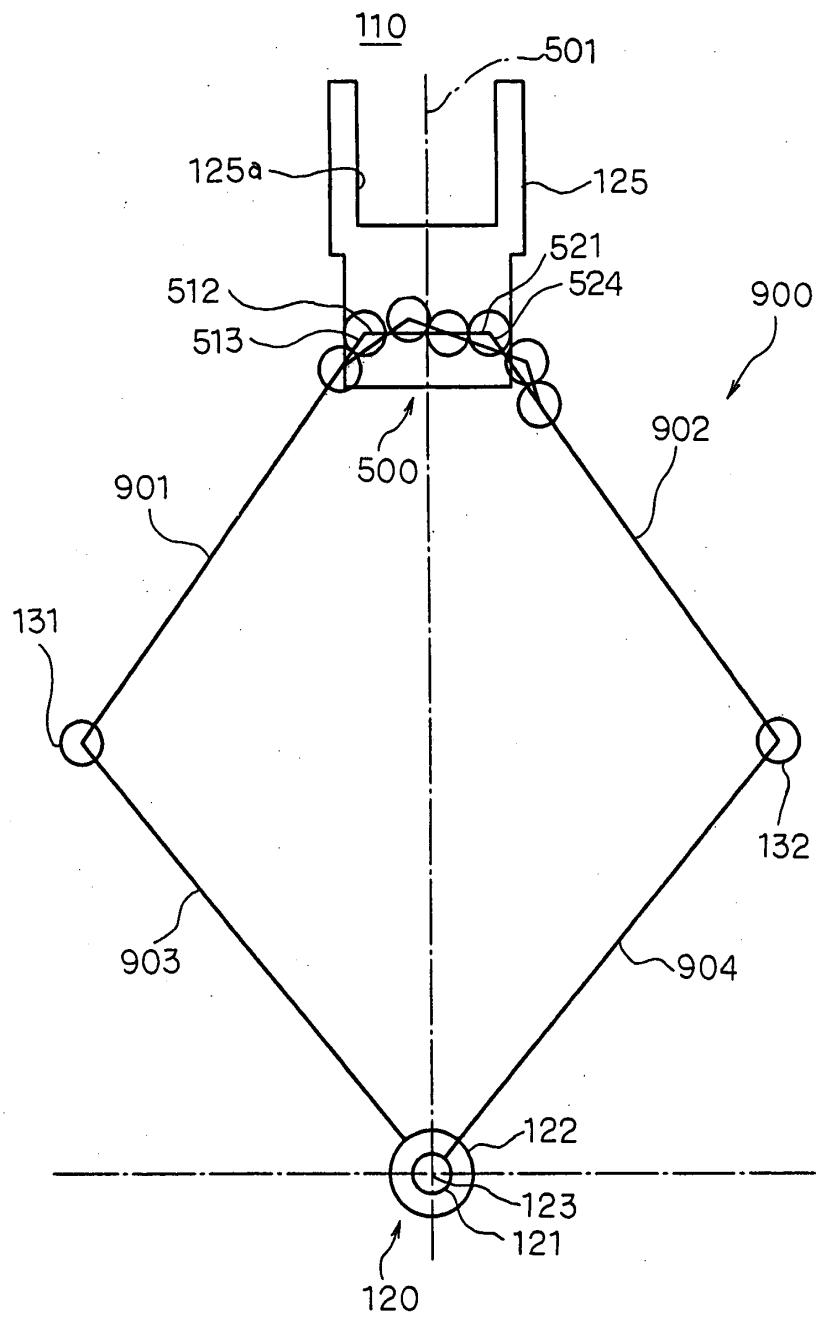


FIG. 22

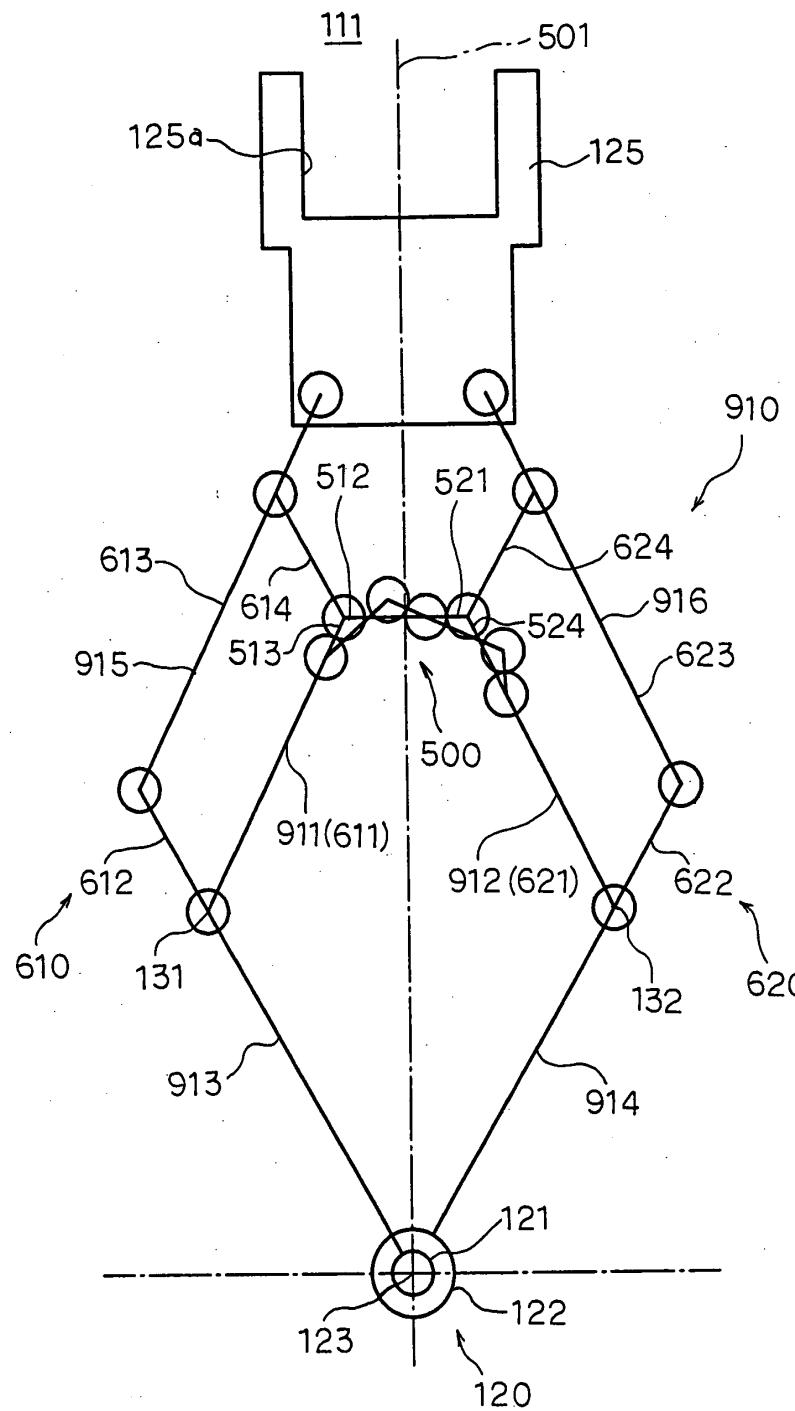


FIG. 23

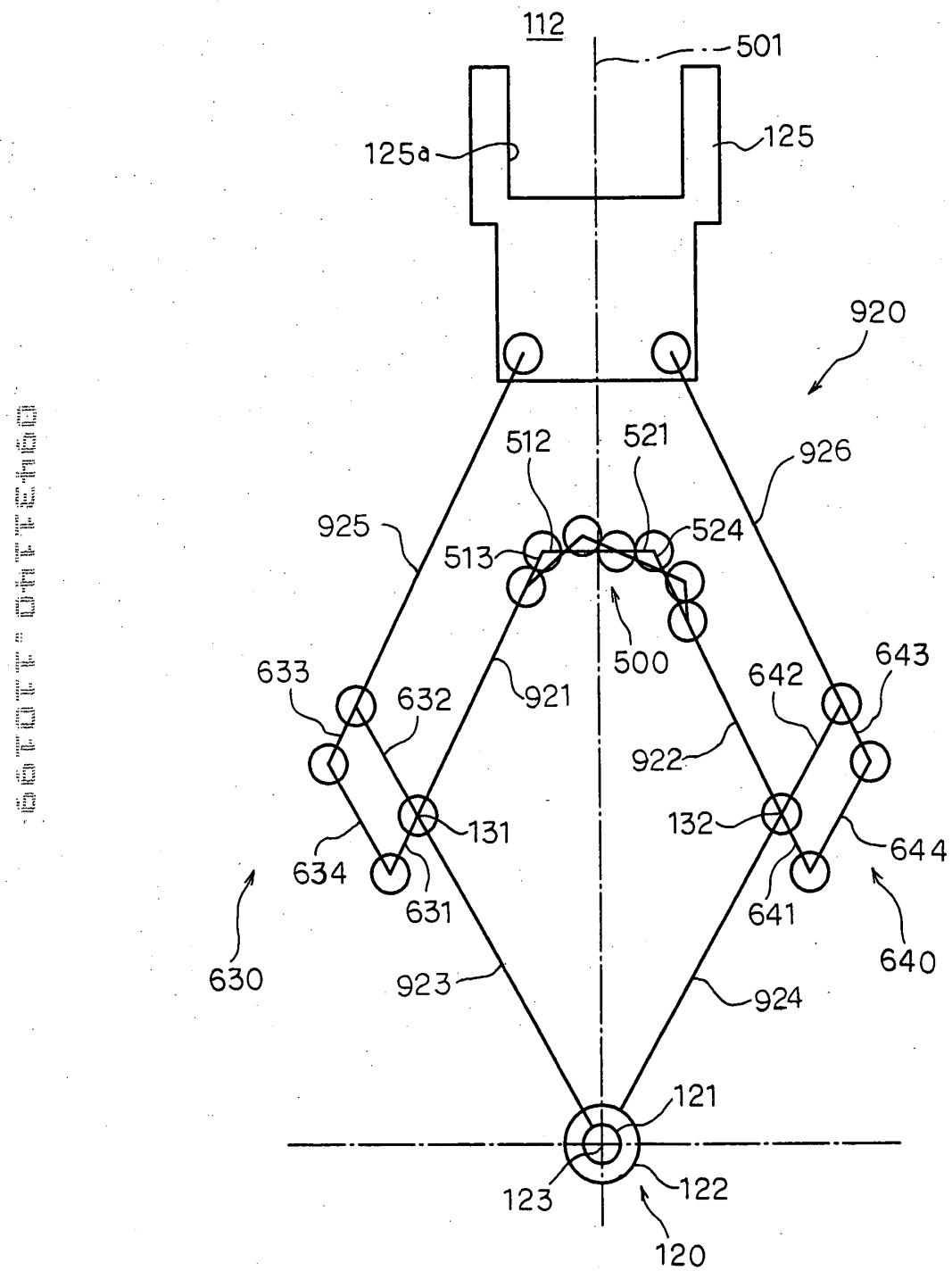
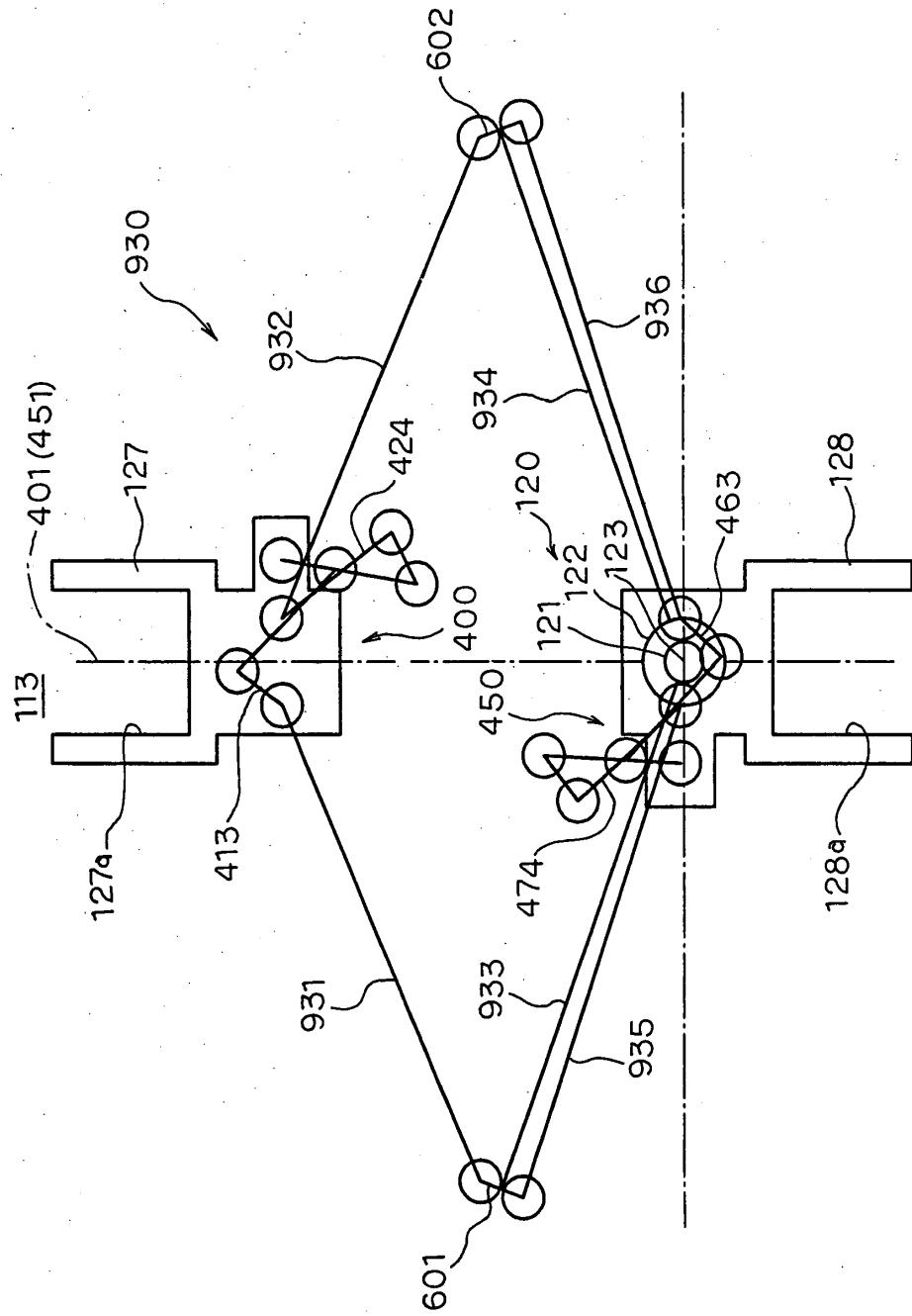


FIG. 24



F I G . 2 5

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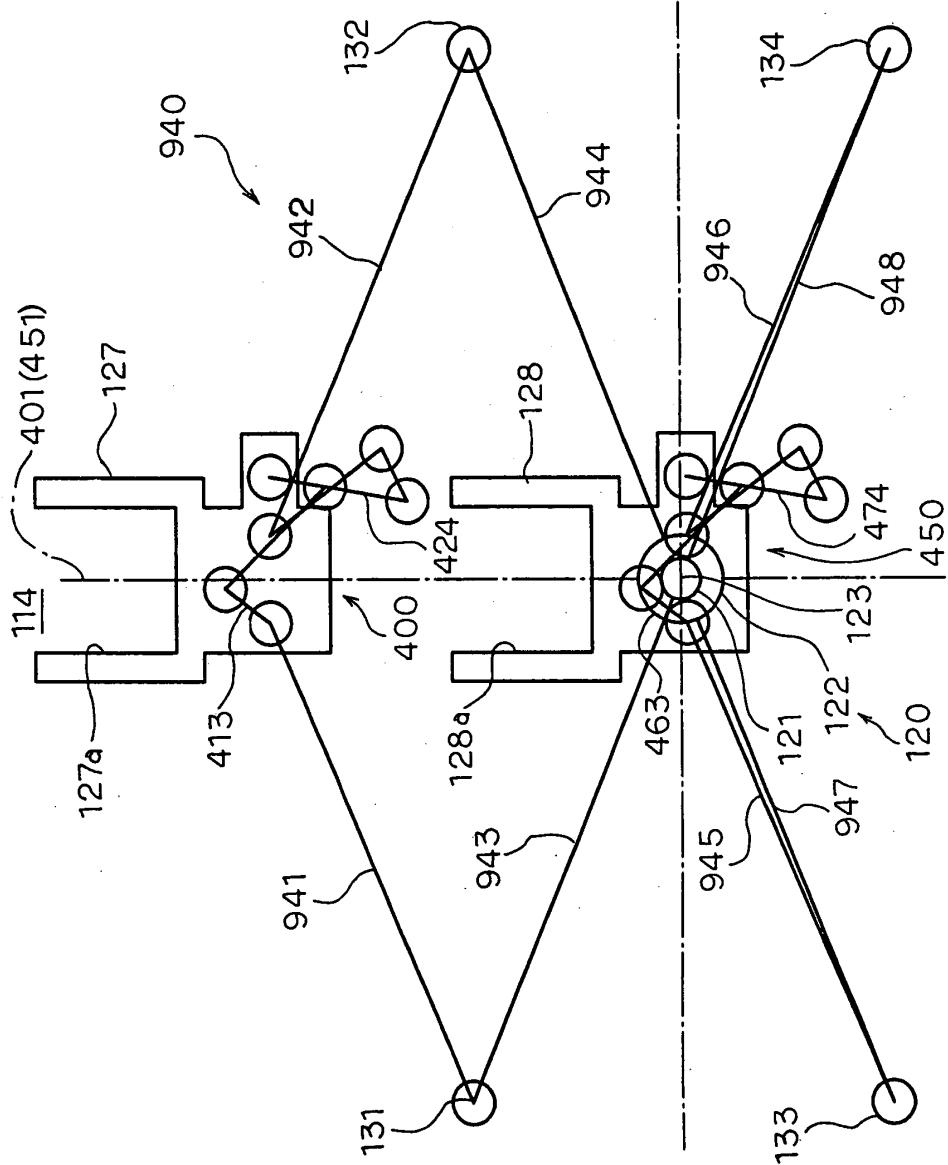


FIG. 26

400(450)

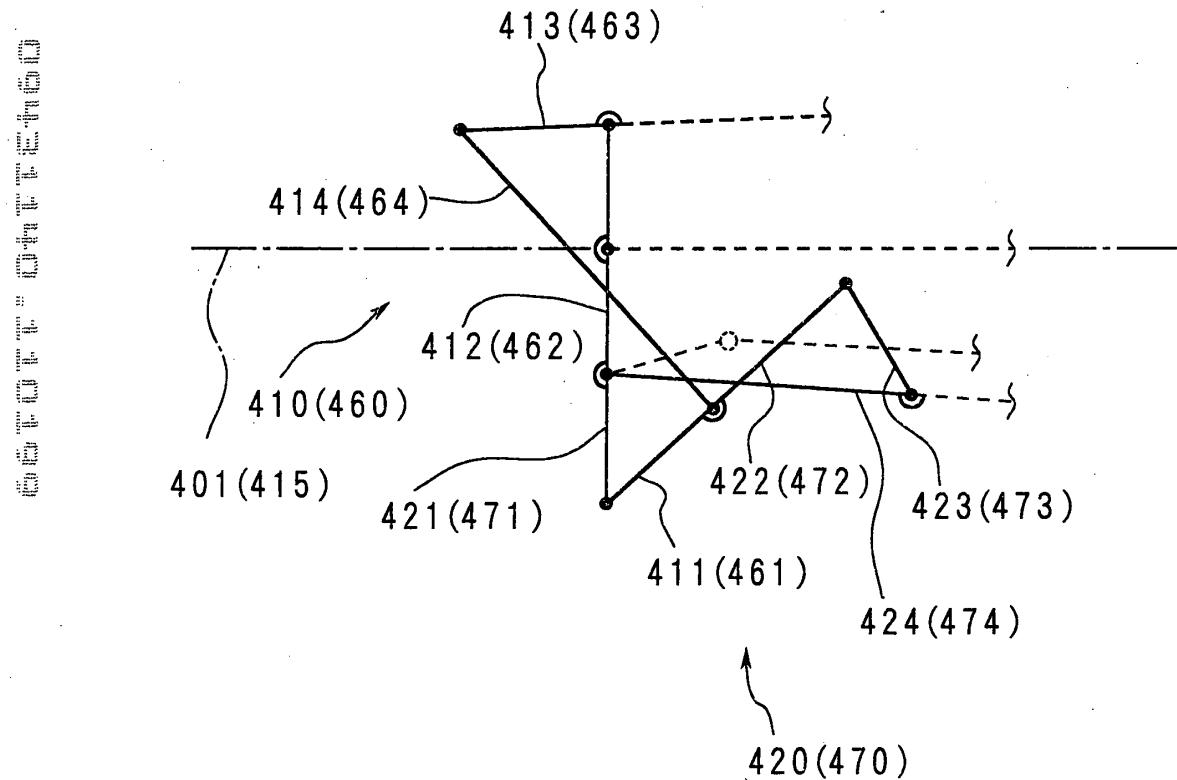
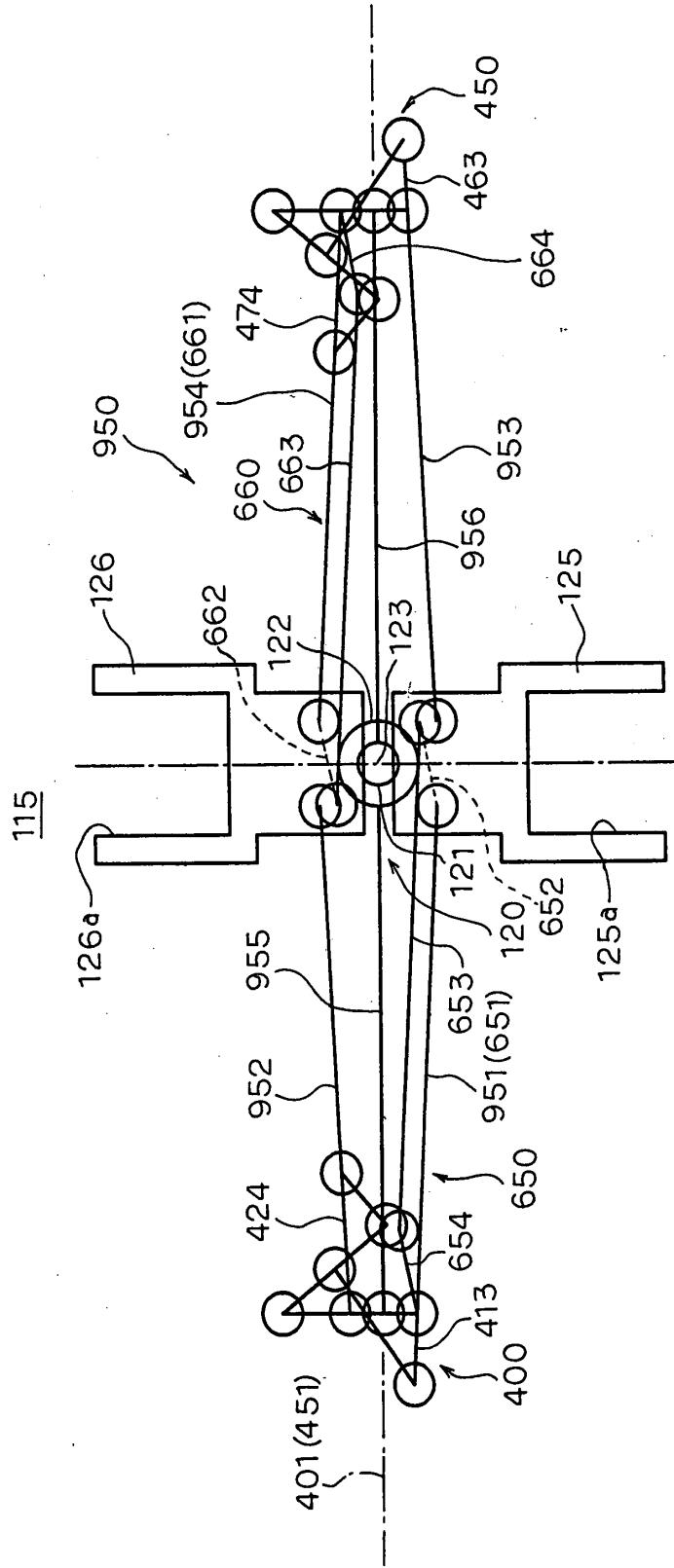


FIG. 27



F I G. 28

500(550)

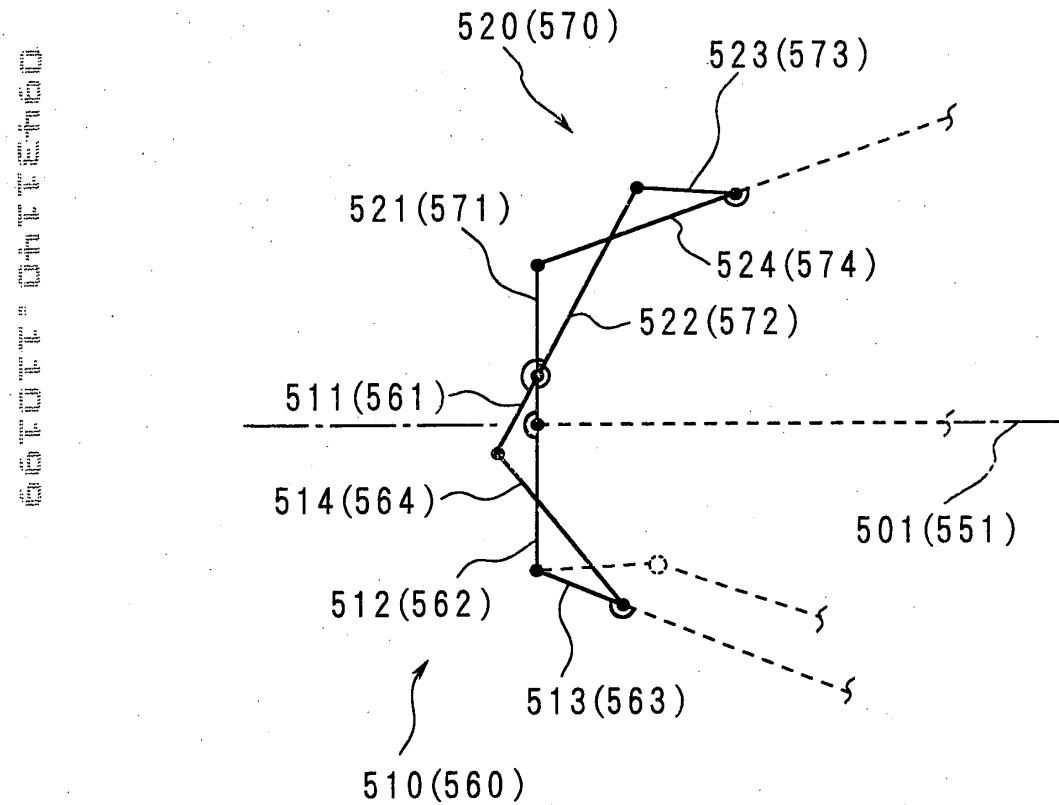


FIG. 29

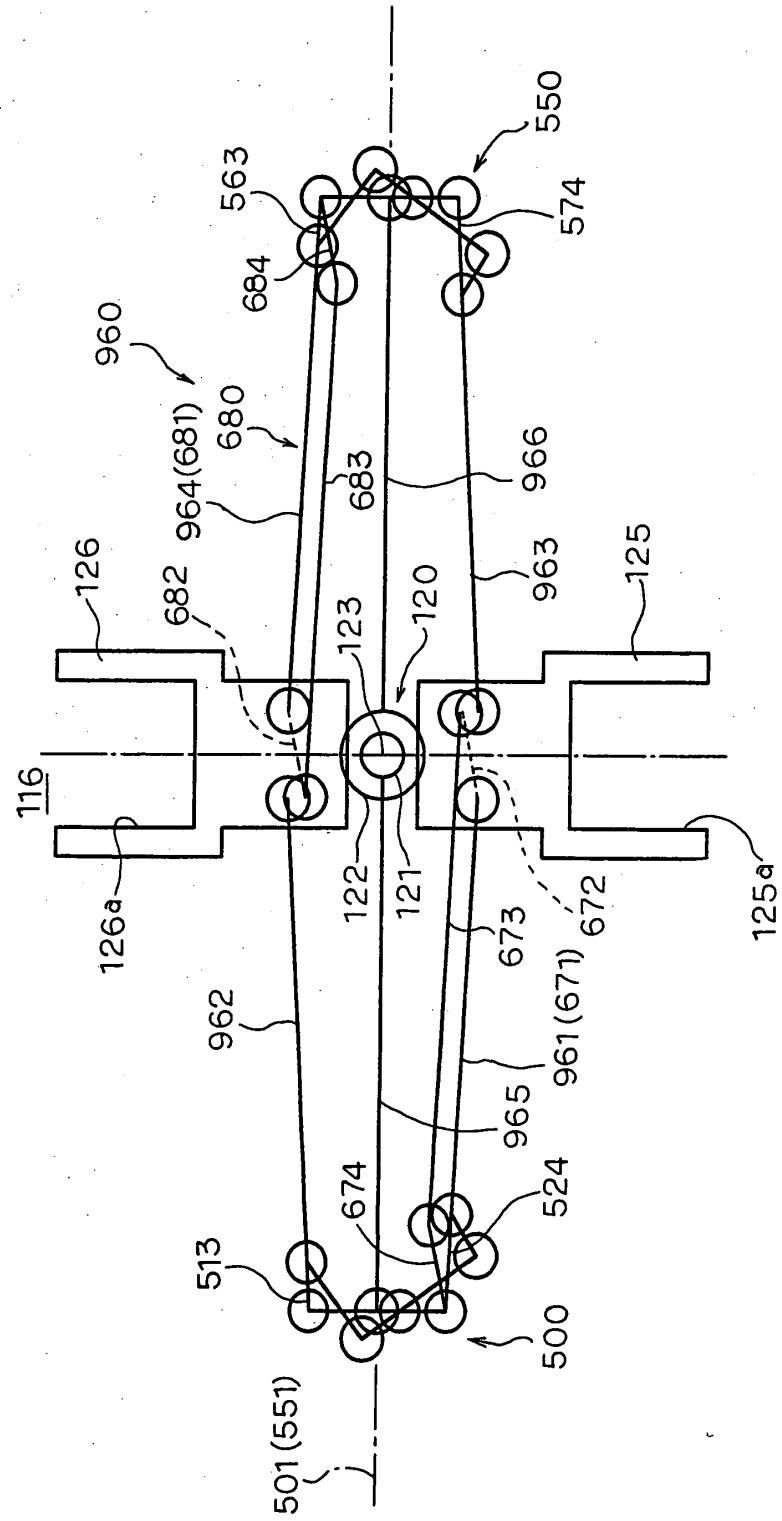
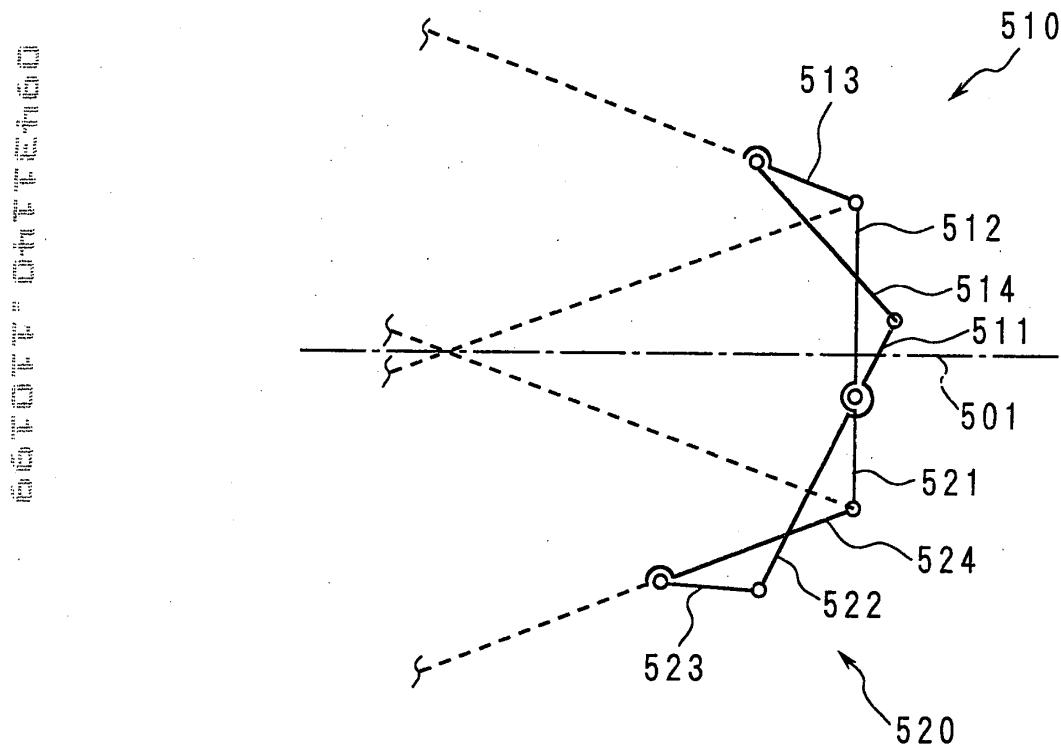


FIG. 30

500



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sub 744.5

FIG. 31

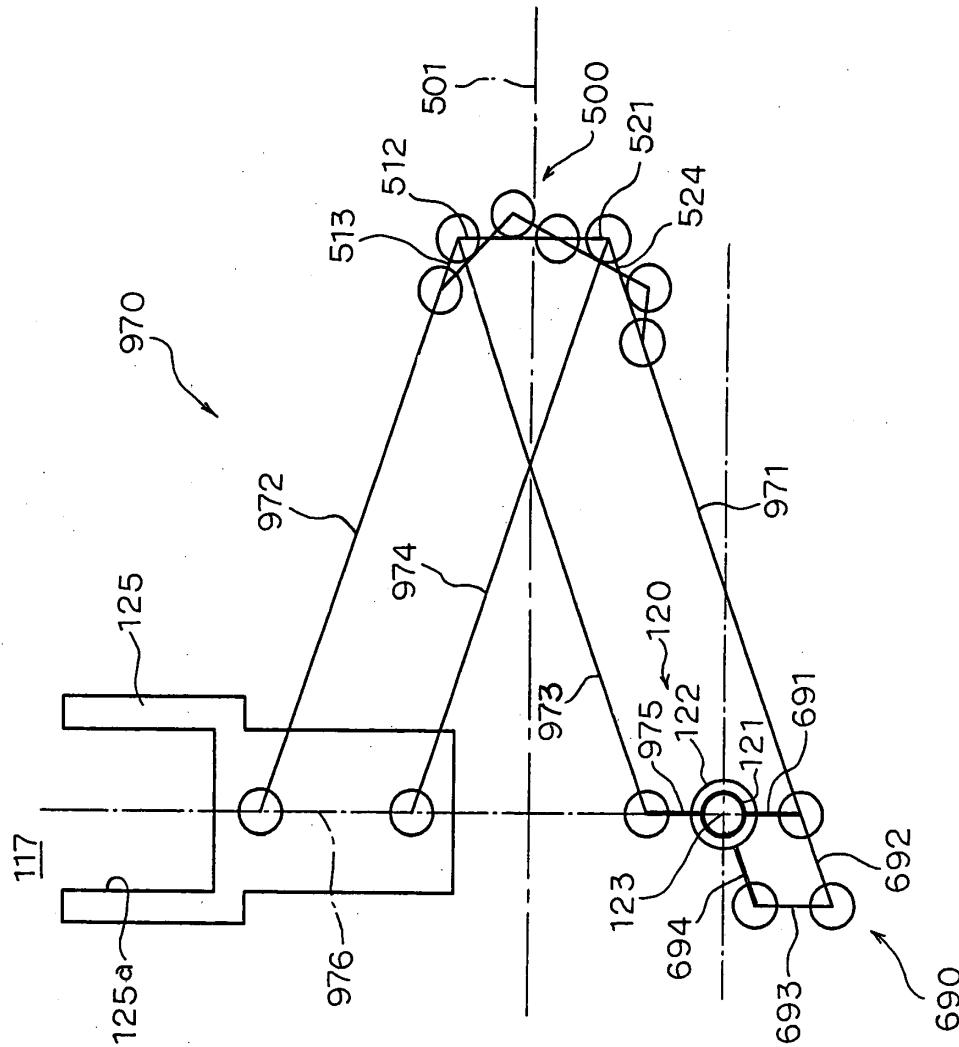


FIG. 32

